



Part Number : [5003300572](#)
Product Description : Mini-B Receptacle, Right-Angle, Surface Mount, 2.50mm Solder Tabs, with Cover Tape, Lead-Free
Series Number : 500330
Status : Active
Product Category : I/O Connectors



Documents & Resources

Drawings

[5003300572_sd.pdf](#)
[SPK-500330-001-001.pdf](#)

3D Models and Design Files

[STEP AP242](#)
[SOLIDWORKS](#)
[Creo](#)

Specifications

[PS-500330-002-001.pdf](#)

Product Environment Compliance

Compliance

GADSL/IMDS	Compliant with Exemption 44; 34; 33
China RoHS	 per SJ/T 11365-2006
EU ELV	Not Relevant
Low-Halogen Status	Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2025)4165-DC (25 June 2025)
EU RoHS	Compliant per EU 2015/863

Compliance Statements

- EU RoHS

- REACH SVHC
- Low-Halogen

Industry Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

Substances of Interest

- PFAS

EU RoHS Certificate of Compliance

Additional Product Compliance Information

Part Details

General

Status	Active
Category	I/O Connectors
Series	500330
Description	Mini-B Receptacle, Right-Angle, Surface Mount, 2.50mm Solder Tabs, with Cover Tape, Lead-Free
Application	Wire-to-Board
Component Type	Receptacle
Product Name	USB
Standard	USB 2.0
Type	Mini-B
UPC	822350021807

Electrical

Current - Maximum per Contact	1.0A
Grounding to Panel	Yes
Shielded	Yes
Shield Type	Full Shield
Voltage - Maximum	30V AC (RMS)/DC

Physical

Circuits (Loaded)	5
-------------------	---

Circuits (maximum)	5
Color - Resin	Black
Durability (mating cycles max)	5000
Gender	Female
Keying to Mating Part	Yes
Lock to Mating Part	Yes
Material - Metal	Copper Alloy
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Mounting Style	Top-Mount
Net Weight	737.885/mg
Number of Rows	1
Orientation	Right Angle
Packaging Type	Embossed Tape on Reel
Panel Mount	No
PCB Locator	Yes
PCB Retention	Yes
PCB Thickness - Recommended	1.60mm
Pitch - Mating Interface	0.80mm
Pitch - Termination Interface	0.80mm
Plating min - Mating	0.760µm
Plating min - Termination	1.000µm
Polarized to Mating Part	Yes
Polarized to PCB	No
Ports	1
Temperature Range - Operating	0° to +50°C
Termination Interface Style	Surface Mount
Waterproof / Dustproof	No

Solder Process Data

Max-Duration	10
Lead-Free Process Capability	REFLOW
Max-Cycle	1
Max-Temp	260

This document was generated on Oct 04, 2025